# **Chemical** Science



# **EDGE ARTICLE**

View Article Online



Cite this: Chem. Sci., 2018, 9, 7968

d All publication charges for this article have been paid for by the Royal Society of Chemistry

# models† Michael J. Powell, Da Benjamin A. D. Williamson, Dab Song-Yi Baek, Joe Manzi, a

Phosphorus doped SnO<sub>2</sub> thin films for transparent

conducting oxide applications: synthesis,

optoelectronic properties and computational

Dominic B. Potter, Da David O. Scanlon Dabc and Claire J. Carmalt \*\*D\*\*a

Phosphorus doped tin(iv) oxide (P:SnO<sub>2</sub>) films have been synthesised by an aerosol assisted chemical vapour deposition route. Triethyl phosphate was used as the phosphorus dopant source. The phosphorus concentration in solution was found to be key to electrical properties, with concentrations between 0.25-0.5 mol% phosphorus giving the lowest resistivities of the deposited films. The conductivity of the films synthesised improved on doping SnO $_2$  with phosphorus, with resistivity values of 7.27 imes  $10^{-4}~\Omega$  cm and sheet resistance values of 18.2  $\Omega$   $\Box$ <sup>-1</sup> achieved for the most conductive films. Phosphorus doping up to 1.0 mol% was shown to improve visible light transmission of the deposited films. The phosphorus doping also had a significant effect on film morphology, with varying microstructures achieved. The films were characterised by X-ray diffraction, scanning electron microscopy, UV/vis spectroscopy, Hall effect measurements and X-ray photoelectron spectroscopy. The data generated was used to build computational models of phosphorus as a dopant for SnO<sub>2</sub>, showing that the phosphorus acts as a shallow one-electron n-type donor allowing for good conductivities. Phosphorus does not suffer from self-compensation issues associated with other dopants, such as fluorine.

Received 15th May 2018 Accepted 23rd August 2018

DOI: 10.1039/c8sc02152j

rsc.li/chemical-science

# Introduction

Transparent conducting oxides (TCOs) are fundamentally important in solar cells, 1-3 flat-screen displays, 4,5 organic light emitting diodes,6,7 touchscreen displays8,9 and liquid crystal displays.10 There are several techniques for depositing thin films of TCO materials, including, magnetron sputtering, 11-13 spray pyrolysis, 14,15 atmospheric pressure chemical vapour deposition,16,17 aerosol assisted chemical vapour deposition (AACVD)18,19 and sol-gel synthesis.20,21

For industrial production of TCO materials high throughput techniques, such as chemical vapour deposition and magnetron sputtering, are favoured for producing conformal coatings over large areas of substrate. Atmospheric pressure CVD can deliver high growth rates, with highly conformal coatings and are used commercially in the production of functional coatings, such as Pilkington Activ<sup>TM</sup>. Doping of materials by atmospheric pressure CVD techniques is not a trivial matter. This is due to the incorporation of the dopant being controlled by the vapour pressure of the precursor, small changes in temperature or gas flow rate can lead to dramatic changes in incorporation of dopants into the host matrix.

Aerosol assisted CVD relies on the ability to produce an aerosol from a solution containing a suitable metal precursor. This eliminates the need for the precursor to be volatile, with the precursor only needing to be soluble in a suitable solvent, i.e. a solvent that can be atomised to generate a mist, for synthesis to be achieved.22 This allows for a far larger range of precursors to be used for the synthesis of functional thin film coatings. In a typical AACVD reaction, the aerosol is carried to the reaction chamber by a carrier gas, where it passes over a heated substrate resulting in nucleation, reaction and film growth. AACVD has several advantages for depositing materials, such as greater sustainability,23 a wider range of precursors, precise control over dopant concentrations and ease of codoping materials.22 AACVD also has the potential to be a scalable process, although consideration of the choice of solvent would be critical, with water being the ideal solvent for sustainability, safety and reduction of unwanted waste products.24

Wide-bandgap (above 3.1 eV) semiconductor metal oxides, such as indium tin oxide (ITO),25-27 Al-doped zinc oxide

<sup>&</sup>lt;sup>a</sup>Department of Chemistry, University College London, 20 Gordon Street, London WC1H 0AJ, UK. E-mail: c.j.carmalt@ucl.ac.uk

<sup>&</sup>lt;sup>b</sup>Thomas Young Centre, University College London, Gower Street, London WC1E 6BT,

Diamond Light Source Ltd, Diamond House, Harwell Science and Innovation Campus, Didcot, Oxfordshire OX11 0DE, UK

<sup>†</sup> Electronic supplementary information (ESI) available. See DOI: 10.1039/c8sc02152j

Edge Article Chemical Science

(AZO)<sup>28-30</sup> and F-doped tin oxide (FTO)<sup>5,31,32</sup> are commonly employed for use as TCOs. ITO has been shown to have film resistivities as low as  $5 \times 10^{-5} \Omega$  cm, mobilities of ca. 100 cm<sup>2</sup>  $V^{-1}$  s<sup>-1</sup> and charge carrier densities of 1.5  $\times$  10<sup>21</sup> cm<sup>-3</sup>.33 For AZO, film resistivities of  $2 \times 10^{-4} \Omega$  cm, mobilities of ca. 50 cm<sup>2</sup>  $V^{-1}$  s<sup>-1</sup> and charge carrier densities of  $5 \times 10^{20}$  cm<sup>-3</sup> have been reported.34 FTO has been shown to have film resistivities as low as  $4 \times 10^{-4} \Omega$  cm, mobilities of ca. 40 cm<sup>2</sup> V<sup>-1</sup> s<sup>-1</sup> and charge carrier densities of  $4 \times 10^{20} \text{ cm}^{-3.5}$  ITO is the most commonly used TCO material in industry, owing to the low resistivity, high charge carrier concentration and high charge carrier mobility of the material.35 ITO, however, is expensive due to the high price of extracting and processing indium.36 There are also concerns over the relative scarcity of indium and the competing demands for indium from flat-screen displays and photovoltaic applications.<sup>37</sup> As a consequence, there has been a focus on producing TCO materials that do not require the use of indium.

Tin(IV) oxide is an ideal candidate for use as a TCO material. Undoped SnO<sub>2</sub> has a band-gap of  $\sim$ 3.6 eV making it transparent to visible wavelengths,38 it is also intrinsically an n-type semiconductor and can be doped to improve its electrical properties. Common dopants to improve the electrical properties include; fluorine, 5,31,39 antimony, 40-42 tantalum 43-46 and niobium. 46-48 Although there have been limited reports on the use of phosphorus as a dopant to improve electrical properties, 49-53 to the best of our knowledge, there has yet to be a report on the use of phosphorus doping of tin(iv) oxide synthesised by AACVD. Outlined in this paper is the effect that the phosphorus precursor, triethyl phosphate, has on the electrical, visible and morphological properties of SnO2 thin films deposited by AACVD. Coupled to the experimental work are computational studies that explore why phosphorus is an effective n-type dopant for SnO2 and showing how the phosphorus contributes to the improvement of the functional properties of the deposited films. Combining the experimental and computational results displays the potential of further increasing the functional properties of SnO2 thin films for TCO materials.

# 2. Experimental

All chemicals were used as bought, without further purification: monobutyltin trichloride (95%, Sigma-Aldrich), triethyl phosphate (99.8%, Sigma-Aldrich) and methanol (99.9%, Fisher), were used as the tin and phosphorus precursors and solvent respectively. Compressed air (21% ( $\pm 0.5\%$ ) O<sub>2</sub> in N<sub>2</sub>) was used as the carrier gas for all reactions, supplied from BOC. The glass substrate used for depositions was 3.2 mm thick plain float glass with a 50 nm thick SiO<sub>2</sub> barrier layer (Pilkington/NSG).

#### 2.1 Thin film synthesis

In a typical deposition, triethyl phosphate (0.0136 g, 7.5 mmol) was added to  $BuSnCl_3$  (0.3 g, 1.1 mmol) dissolved in methanol (20 mL) with stirring. The methanol solution was allowed to stir for ca. 10 min. Varying molar ratios of the P to Sn precursor were used to deposit a range of films. In the 7.5 mol% P:Sn film, the amount of triethyl phosphate to use (0.0136 g, 7.5 mmol) was

calculated from the amount of  $BuSnCl_3$  in the solution. Precursor solutions containing 0.0, 0.1, 0.25, 0.5, 1, 1.5, 5 and 7.5 mol% P:Sn content were prepared in this manner.

The AACVD thin film depositions were carried out as detailed elsewhere.31 Briefly, a carbon block heater comprising the lower half of the reactor was used to maintain the substrate temperature using a k-type thermocouple. Depositions were carried out on Pilkington silica-coated barrier glass (50 nm SiO2 coated on one side of float glass) in order to prevent unwanted leaching of ions from the glass into the thin film.54 Prior to deposition, the glass substrates were cleaned with soapy water, isopropanol and acetone and were then left to air dry. The substrate was then loaded into the reaction chamber along with a second piece of float glass suspended 8 mm above (silica barrier layer pointing down) to ensure laminar flow during deposition. An aerosol mist of the precursor solution was generated using a 'Liquifog' piezo ultrasonic atomizer from Johnson Matthey, which uses an operating frequency of 1.6 MHz to produce a mode droplet size of ca. 3 µm. The mist was transported into the reactor *via* a baffle, using compressed air, as the carrier gas, at a constant flow-rate of 1.0 L min<sup>-1</sup>. The exhaust of the reactor was vented into a fume cupboard. When the precursor solution and associated aerosol mist had been completely emptied from the bubbler, the coated substrate was cooled to below 100 °C before being removed from the reactor. Deposition temperatures were fixed at 550 °C, as below this temperature carbon contamination made the films less visibly transparent. Typical deposition times were between 30-40 min. Sample descriptions can be found in Table 1.

#### 2.2 Thin film characterisation

Scanning electron microscope images were recorded on a Jeol JSM-6301F SEM at an acceleration voltage of 5 kV. X-ray diffraction (XRD) patterns were recorded using a Bruker D8 Discover Xray diffractometer using monochromatic Cu  $K_{\alpha 1}$  and Cu  $K_{\alpha 2}$ radiation of wavelengths 1.54056 and 1.54439 Å respectively, emitted in an intensity ratio of 2:1 with a voltage of 40 kV and a current of 40 mA. The incident beam angle was 1° and data was collected between 5° and 66°  $2\theta$  with a step size of 0.05° at 1.0 s per step. All diffraction patterns obtained were compared with database standards (ICSD). Unit cell volumes and lattice parameters were calculated from the XRD data using GSAS and EXPGUI programs. X-ray photoelectron spectroscopy was conducted on a Thermo Scientific K-alpha spectrometer with monochromated Al Kα radiation, a dual beam charge compensation system and constant pass energy of 50 eV (spot size 400 µm). Survey scans were collected in the binding energy range 0-1200 eV. High-resolution peaks were used for the principal peaks of Sn (3d), O (1s), P (2s) and C (1s). Data was calibrated against C 1s (285.0 eV). Data was fitted using CASA XPS software. UV/vis spectra were recorded on a Perkin Elmer Lambda 950 UV/vis/ NIR Spectrophotometer in both transmission and diffuse reflectance mode. A Labsphere reflectance standard was used as a reference for the UV/vis measurements. Room temperature Hall effect measurements were carried out on an Ecopia HMS-3000 set up in the Van der Pauw configuration. Measurements

Table 1 Descriptions for thin films deposited, their lattice cell parameters and volumes and P: Sn ratio from EDX. All samples were deposited at

550 °C with compressed air used as the carrier gas. The mol% of triethyl phosphate in precursor solution is given and the at% P in the resulting film as determined from EDX. Undoped lattice parameters and cell volume values were obtained from ICSD reference SnO<sub>2</sub> (9163-ICSD)

Sample description mol% of triethyl phosphate in solution	Lattice parameter $a = b \text{ (Å)}$	Lattice parameter $c$ (Å)	Cell volume (ų)	P : Sn ratio in film/at%
Undoped SnO <sub>2</sub> thin film	4.738(1)	3.187(2)	71.53	_
0.1% P:SnO <sub>2</sub> thin film	4.749(1)	3.181(1)	71.75(2)	_
0.25% P:SnO <sub>2</sub> thin film	4.7444(5)	3.1905(6)	71.82(1)	_
0.5% P:SnO <sub>2</sub> thin film	4.7449(4)	3.1880(7)	71.78(2)	0.26:99.74
1.0% P:SnO <sub>2</sub> thin film	4.7419(1)	3.190(1)	71.70(3)	0.62:99.38
1.5% P:SnO <sub>2</sub> thin film	4.737(1)	3.188(1)	71.53(3)	0.69:99.31
5.0% P:SnO <sub>2</sub> thin film	4.740(2)	3.184(2)	71.55(4)	1.42:98.58
7.5% P:SnO <sub>2</sub> thin film	4.745(2)	3.182(2)	71.65(5)	_

were taken using a 0.58 T permanent magnet and a current of 1  $\mu$ A. Tests were carried out on square-cut samples measuring ≈1 × 1 cm. Silver paint (Agar Scientific) was used to form ohmic contacts, which were tested on the in-built software prior to measurement. The Hall effect method was used to find the  $\rho$ ,  $\mu$ and n using measured film thickness values as obtained from a Filmetrics F20 machine operating in reflectance mode in air against an as-supplied SnO<sub>2</sub> standard.

#### 2.3 Computational modelling

**Chemical Science** 

Theoretical methodology. The intrinsic and extrinsic defects simulated in this work were calculated using ab initio density functional theory (DFT) utilising the periodic code VASP. 55-58 The projector-augmented wave (PAW)59 method was used to account for the interactions between the core and valence electrons for each species (Sn[Kr], O[He], P[Ne]). The geometric optimisations and electronic relaxations were carried out using the PBE0 (Perdew-Burke-Ernzerhoff) hybrid functional formalised by Adamo and Barone. 60,61 PBE0 gives an accurate description of the band gap of SnO<sub>2</sub> compared to standard DFT functionals which are limited by their failure to describe the self-interaction error. PBE0 has also been shown to accurately predict the properties of tin-based oxides.62-71 The 72 atom 2  $\times$  2  $\times$  3 supercells were based on a previously calculated geometry relaxation carried out on the conventional cell for SnO<sub>2</sub> using a 400 eV plane-wave cutoff and a  $4 \times 4 \times 6$   $\Gamma$ -centred k-point mesh.<sup>62</sup> All the defect supercells and their respective charge states were calculated using  $\Gamma$ -centred k-point meshes of 2  $\times$  2  $\times$  2 and plane-wave energy cut-offs of 400 eV. Each structural optimization involved the relaxation of the ions whilst keeping the lattice vectors/angles/volumes fixed. Convergence was deemed complete when the forces on all the atoms were  $< 0.01 \text{ eV atom}^{-1}$ . The limiting phase, P<sub>2</sub>O<sub>5</sub> was relaxed using a planewave energy cut-off of 600 eV and a  $\Gamma$ -centred k-point mesh of  $4 \times 4 \times 6$ .

**Defect formalism.** The corrected formation energy of a defect in charge state 'q',  $\Delta H_f(D,q)$  can be defined as:

$$\Delta H_{\rm f}(D,q) = \left(E^{D,q} - E^{\rm H}\right) \pm \sum_{i} n(E_i + \mu_i)$$

$$+ q\left(E_{\rm Fermi} + \varepsilon_{\rm VBM}^{\rm H} + \Delta E_{\rm pot}\right) + q^2 E_{\rm corr}^{\rm IC} + E_{\rm corr}^{\rm BF} \qquad (1)$$

 $E^{D,q}$  refers to the total energy of the defective supercell in charge state 'q' and is in reference to the total energy of the host supercell,  $E^{H}$ .  $E_{i}$  and  $\mu_{i}$  correspond to the elemental reference energies (Sn(s), O2(g), P(s)) and their respective chemical potentials. The number of electrons added to or taken away from the external reservoir is notated by n.  $E_{\text{Fermi}}$  refers to the Fermi level and ranges from the valence band maximum (VBM) at 0 eV to 6 eV ( $\sim$ 2.4 eV above the conduction band minimum (CBM)).  $\varepsilon_{\mathrm{VBM}}^{\mathrm{H}}$  is the eigenvalue of the VBM of the host material. Due to the 'finite' size effects of the supercell, three corrections are applied. Firstly, a potential alignment term  $\Delta E_{pot}$  must be added to correct the difference between the potential of the defective supercells and the host supercell. Secondly, an image-charge correction is applied,  $E_{\text{corr}}^{\text{IC}}$ , which, due to the long ranged nature of the coulomb interaction 72,73 corrects for the interaction of the charged defect and its own periodic images. The scheme used herein uses an image charge correction formalised by Hine and Murphy.74 Lastly, due to the high defect concentrations present in supercell calculations, a band filling term ( $E_{corr}^{BF}$ ) is applied to shallow defects in a method by Lany and Zunger. 75,76

Thermodynamic limits. The growth conditions can be represented by the chemical potentials  $(\mu_i)$  and thus simulate the experimental partial pressures of preferential n and p-type defect formation. These are relative to the calculated enthalpy

$$\mu_{\rm Sn} + 2\mu_{\rm O} = \Delta H_{\rm f}^{\rm SnO_2} = -5.27 \text{ eV}$$
(experiment = 5.98 eV (ref. 77)) (2)

Two growth conditions; Sn-rich/O-poor (n-type favourable) and Sn-poor/O-rich (p-type favourable) regimes can therefore be defined limited by the growth of  $Sn_{(s)}$  and  $O_{2(g)}$  respectively:

Sn-rich/O-poor conditions: 
$$\mu_{Sn} = 0$$
 eV;  $\mu_{O} = -2.64$  eV (3)

Sn-poor/O-rich conditions: 
$$\mu_{Sn} = -5.27 \text{ eV}$$
;  $\mu_{O} = 0 \text{ eV}$  (4)

The solubilities of the phosphorus species are limited by the formation of a secondary phase, P2O5:

$$2\mu_{\rm P} + 5\mu_{\rm O} = \Delta H_{\rm f}^{\rm P_2O_5} = -14.80 \text{ eV}$$
  
(experiment = -15.59 eV (ref. 78)) (5)

 $\mu_{\rm P}$  is therefore calculated to be -0.80 eV and -7.40 eV under Snrich/O-poor and Sn-poor/O-rich conditions respectively.

This article is licensed under a Creative Commons Attribution 3.0 Unported Licence.

Open Access Article. Published on 23 Agosti 2018. Downloaded on 19/07/2025 06:42:46.

Edge Article Chemical Science

The thermodynamic transition levels (q/q') can be calculated using the equation:

$$\varepsilon_{\rm D}(q/q') = \frac{\Delta H_{\rm f}(D,q) - \Delta H_{\rm f}(D,q')}{q' - q} \tag{6}$$

And show the evolution of a defect from charge state q to q' at a certain Fermi level position. These are useful experimentally as they can be seen in techniques such as deep level transient spectroscopy (DLTS).

Dependence on oxygen partial pressure and temperature. In order to gain a snapshot of the defect chemistry under experimental conditions, the dependence of  $\mu_{\rm O}$  on the oxygen partial pressure and temperature can be determined using the equation:<sup>79</sup>

$$\mu_{\mathcal{O}}(T, p^{0}) = \frac{1}{2} \left[ H(T, p^{0}, \mathcal{O}_{2}) - H(0 \, \mathcal{K}, p^{0}, \mathcal{O}_{2}) \right]$$

$$= \frac{1}{2} T \left[ S(T, p^{0}, \mathcal{O}_{2}) - S(0 \, \mathcal{K}, p^{0}, \mathcal{O}_{2}) \right]$$
(7)

T, H and S are temperature, enthalpy and entropy respectively and  $p^0=1$  atm with reference to a zero state;  $\mu_{\rm O}(0~{\rm K},p^0)=\frac{1}{2}E_{\rm O_2}^{\rm total}=0.^{\rm so,s1}$  The P:SnO $_2$  films were carried out using AACVD at  $\sim\!900~{\rm K}/1$  atm allowing us to determine the oxygen chemical potential using data from thermochemical tables,  $^{\rm s2}$  therefore:  $\mu_{\rm O}(T,p^0)=-0.97~{\rm eV}.$ 

## Results and discussion

#### 3.1 Thin film characterisation

Thin films of P-doped SnO<sub>2</sub> (P:SnO<sub>2</sub>) were synthesised from monobutyltin trichloride and triethyl phosphate by aerosol

assisted chemical vapour deposition (AACVD) with compressed air as the carrier gas. The concentration of the phosphorus was varied in solution. All films were synthesised at 550  $^{\circ}\text{C}$ , with typical deposition times being 30–40 min.

The films were analysed for their elemental content via energy-dispersive X-ray spectroscopy (EDX) and X-ray photoelectron spectroscopy (XPS). XPS was also used to determine the oxidation state and environments for the elements present in the synthesised film, as shown in Fig. 1. In the XPS, the Sn 3d and P 2s environments were probed, since the Sn 3d and P 2p regions overlap and hence the P 2s had to be used to determine the oxidation state of the phosphorus. For all films deposited, there was only a single Sn environment, which gave values of 487.0 and 495.2 eV for the Sn  $3d_{5/2}$  and Sn  $3d_{3/2}$  respectively. These values matched with literature values for SnO<sub>2</sub> ( $\pm 0.2$ eV).83,84 The oxygen environment gave a combination of O-Sn and O-C at 530.6 and 532.4 eV respectively ( $\pm 0.2$  eV), in agreement with literature values. 85,86 The P 2s peak occurred at a value of 191.2 eV ( $\pm 0.2$  eV), which is commonly seen for phosphorus in the 5+ state.87,88 As the phosphorus precursor, triethyl phosphate, also formally has the phosphorus as P5+, this suggests that the phosphorus was not reduced when it was incorporated into the SnO2 lattice. This is not surprising, as the depositions were performed in an oxygen rich environment, which should keep the phosphorus in its maximum oxidation state.

Although phosphorus was detected within the XPS data, the signal was weak with a high noise to signal ratio, which indicates that the at% of phosphorus in all the P-doped samples were  $\sim$ 1 at% or below, since this is the threshold of reliable detection for XPS. Therefore, although the phosphorus can be detected and can be seen in both the change in morphology from the SEM images and change in electrical resistivity from

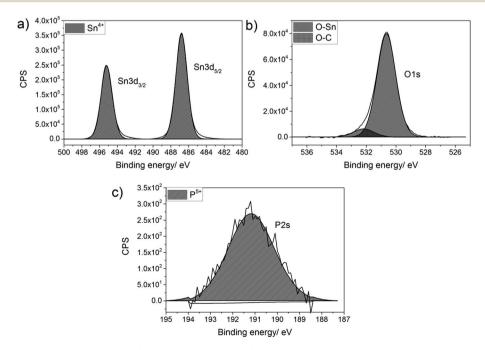


Fig. 1 Typical X-ray photoelectron spectra for (a) Sn 3d environment, (b) O 1s environment and (c) P 2s environment for P-doped  $SnO_2$  films synthesised by AACVD at 550 °C.

the Hall effect data (*vide infra*), the measured values cannot be included as the error on these would be larger than the value calculated from the XPS data.

**Chemical Science** 

To determine whether the phosphorus was segregated in the films, or uniformly dispersed, depth profiling was performed on the samples. This showed that the phosphorus was bulk segregated, with the P to Sn ratio increasing on etching of the films. In order to determine the amount of P present in each of the films EDX was used. The EDX results showed a gradual increase in the P content in the films with increasing mol% P precursor in the AACVD precursor solution (Table 1) from 0.5 mol% until 5 mol%. For films deposited using ≤0.25 mol% and 7.5 mol% triethyl phosphate, the P content in the films was too low to be accurately reported (<0.1 at%) although XPS and the observed change in morphology and XRD (vide infra) provide evidence of low quantities of P in these films. AACVD precursor solutions containing 0.5, 1.0 and 1.5 mol% triethyl phosphate produced SnO<sub>2</sub> films with 0.26, 0.62 and 0.69 at% P, respectively. The films formed from 5 mol% triethyl phosphate in the precursor solution contained 1.42 at% before doping to very low levels using 7.5 mol%, suggesting possible saturation was reached at 5 mol% P. A similar effect was observed in the deposition of Sb-doped TiO2 films via AACVD where precursor solutions with >2.5 mol% Sb inhibited the incorporation of Sb in the TiO<sub>2</sub> and reduction of the Sb(OEt)<sub>3</sub> precursor occurred.89

X-ray diffraction (XRD) was used to determine the phase present in the samples synthesised, Fig. 2. All XRD patterns displayed diffraction peaks that were referenced to the cassiterite phase of  $\rm SnO_2$ . The incorporation of phosphorus has several effects on the patterns displayed. The most obvious change was to the intensity of the (110) plane, this was the most intense diffraction peak for the undoped  $\rm SnO_2$  film. On incorporation of phosphorus, however, the intensity of the reflection of this plane was significantly reduced in the XRD data. The intensity of this diffraction peak then remains low throughout the various phosphorus dopant concentrations. This suggests that phosphorus retards crystal growth in this direction.

Preferred orientation was observed in (101) and (211) planes for films formed using  $\leq$ 0.25 mol% triethyl phosphate. The (200) plane was suppressed when using 1.5 mol% or higher P precursor, with preferred orientation occurring in the (101)/(200)/(211) planes for films formed with 0.5 mol% and 1.0 mol% triethyl phosphate. The highest amount of 7.5 mol% P precursor showed that the (211) plane was also suppressed. Preferred orientation in the (211) plane has been observed previously for Sb-doped SnO<sub>2</sub> films. <sup>90,91</sup> For F-doped SnO<sub>2</sub> thin films, a preferential orientation towards the (200) is commonly observed for highly conductive films. <sup>5,92</sup>

It was noticeable that at high dopant concentrations, the phosphorus appeared to reduce the overall crystallinity of the films since all the diffraction peaks become weaker and less well defined. Interestingly, this effect was only displayed for the (211) plane at concentrations above 5 mol% triethyl phosphate in the precursor solution, whereas the (101) and (200) display this reduction in intensity at lower concentrations of phosphorus. This has been previously observed for phosphorus doped  $\mathrm{SnO}_2$  films synthesised by the simultaneous oxidation of phosphine

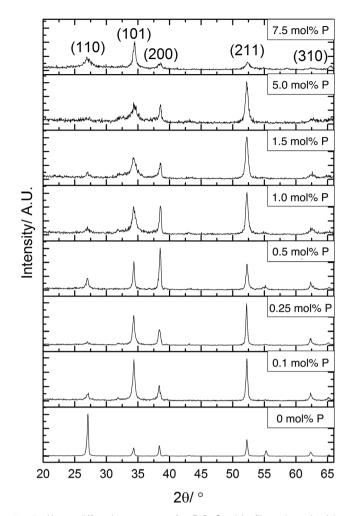


Fig. 2 X-ray diffraction patterns for  $P:SnO_2$  thin films deposited by AACVD at 550 °C. A change in preferred orientation is observed between undoped, and inclusion of phosphorus into the crystal structure.

and tetramethyltin,<sup>49</sup> where above 3.2 at% phosphorus content, the crystallinity of the films rapidly diminished.

From the XRD patterns a shifting of the diffraction peaks to higher angles at greater phosphorus concentrations was observed. This suggests that phosphorus was being incorporated into the  $SnO_2$  lattice, with the smaller ionic radius of P(v) (34 pm compared to Sn(iv) which is 71 pm) leading to a reduction in the lattice parameters.

The data from the XRD patterns was used to calculate the lattice parameters for the films and observe how these were affected by the inclusion of phosphorus, as shown in Table 1. Due to the poor crystallinity of the films at higher dopant concentrations, there was a higher error in the calculated unit cell volumes. The trend apparent in the data showed that phosphorus incorporation leads to a reduction of the crystal lattice. Although there is an apparent initial increase in lattice parameters, this is within the error for the data quality and so is most likely an artefact of the model used to calculate the lattice parameter data. As the phosphorus in the precursor is in the 5+ state, it will most likely replace on tin sites. With phosphorus

**Edge Article Chemical Science** 

being a smaller atom than tin, this would lead to a reduction in lattice parameters, which is seen for higher doping levels.

To determine the effect of phosphorus doping on the morphology of the deposited SnO2 films, scanning electron microscopy (SEM) images were obtained for all samples, Fig. 3. As with the XRD patterns, Fig. 2, the incorporation of phosphorus had a large effect, such that a variation in surface morphology of the deposited samples was observed. Undoped SnO<sub>2</sub>, Fig. 3a, displayed typical pyramidal structures associated with SnO2 deposited by AACVD processes.93

Phosphorus doping has a remarkable effect on the morphology of the samples. Even at low %mol in solution (0.1 mol%), Fig. 3b, a lowering of the average size of the particles present was observed. The particles are also much rounder, with a loss of the pyramidal shape. With higher phosphorus %mol in the precursor solution, the particles become more rod-like in shape. This is supported in the XRD patterns for this sample (0.25 mol%), where the (101) plane had high intensity and the (110) plane was very low in intensity, this is known to favour rodlike particle formation for SnO2.94 Interestingly, although films formed using 0.1 mol% and 0.25 mol% P precursor in solution show similar XRD patterns and relative preferred orientations, the 0.1 mol% has a higher relative intensity in the (110) plane, which appears to prevent the growth of the rod-like particles.

The other feature in the morphology for films deposited using 0.25 mol% triethyl phosphate in solution (Fig. 3c) is the presence of a continuous layer that covers the rod-like particles; this is shown in the top right hand corner of the image. This uniform layer does not appear to be made of any obvious individual particles, which suggests that phosphorus incorporation can control grain boundary growth. Control of grain boundaries has been shown to improve the properties of graphene,95 silicon96 and zirconia97 layers/thin films.

With increasing phosphorus %mol in the starting precursor solution, the pyramidal particle shape was once again present. The particle shapes were not, however, identical to undoped SnO<sub>2</sub>. The particles were more angular and jagged, resembling shark's teeth, Fig. 3d-f. This coincides with a loss in intensity in the (101) plane for the XRD patterns for these samples and a change in preferential orientation to the (200) plane for films deposited using 0.5 mol% P precursor. This type of morphology has been previously observed for F-doped SnO2 with preferred orientation in the (200) plane.98

UV/vis spectra were obtained for all deposited films to determine the effect of the incorporation of phosphorus on the optical properties of the films, Fig. 4. As shown, the phosphorus incorporation initially led to a small increase in the visible light transmission of the films formed using 0.25 mol% triethyl phosphate in the precursor solution which gave visible light transmission ca. 82% (400–700 nm), this was above the visible light transmission of the undoped sample (80.8%). Further increasing the concentration, however, led to a significant worsening of the visible light transmission. Films that were deposited from solutions with higher than 1 mol% triethyl phosphate had a significant yellow hue to their colour, when observed in transmission, so it is not surprising that these films were poorer at allowing visible light to be transmitted. Colour centres are known to be caused by defects, such as oxygen vacancies, with doping of metal oxides often leading to an increase in the number of these defects. 99,100

#### 3.2 Functional testing

In order to determine the electrical properties of the deposited films, Hall effect measurements were obtained, shown in Table 2. Undoped SnO<sub>2</sub> and the use of high concentrations of triethy phosphate (7.5 mol% P) led to films that were too

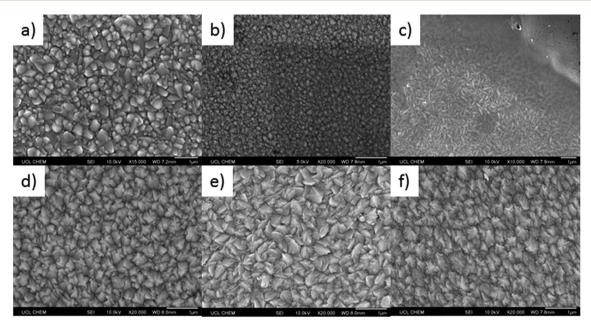


Fig. 3 Typical SEM images showing the surface morphology for (a) undoped SnO<sub>2</sub>, (b) 0.1 mol% P:SnO<sub>2</sub>, (c) 0.25 mol% P:SnO<sub>2</sub>, (d) 0.5 mol% P:SnO<sub>2</sub>, (e) 1.0 mol% P:SO<sub>2</sub>, and (f) 1.5 mol% P:SnO<sub>2</sub> thin films on glass. All samples were produced at 550 °C, by aerosol assisted CVD using compressed air as the carrier gas.

**Chemical Science** 

a' b) %Transmission/Reflectance C) d) 

Fig. 4 UV/vis/NIR spectra for P-doped SnO<sub>2</sub> films; (a) undoped SnO<sub>2</sub> (1) and 0.1 mol% P:SnO<sub>2</sub> (2); (b) 0.25 mol% P:SnO<sub>2</sub> (3) and 0.5 mol% P:SnO<sub>2</sub> (4); (c) 1 mol% P:SnO<sub>2</sub> (5) and 1.5 mol% P:SnO<sub>2</sub> (6); and (d) 5 mol% P:SnO<sub>2</sub> (7) and 7.5 mol% P:SnO<sub>2</sub> (8). In all cases the films showed high transmission (ca. 80%) and low reflection (<20%). All films deposited by AACVD at 550 °C using air as carrier gas.

Wavelength/ nm

Table 2 Table of electrical and optical data for all P-doped  $SnO_2$  samples synthesised in air by AACVD of <sup>n</sup>BuSnCl<sub>3</sub> and OP(OEt)<sub>3</sub> in methanol at 550 °C. Undoped  $SnO_2$  and the film from 7.5 mol% P were too resistive to obtain Hall effect measurements. Samples are compared to industrial F-doped  $SnO_2$  standards<sup>a</sup>

Sample	$d~\mu\mathrm{m}^{-1}$	$n/\times 10^{20} {\rm cm}^{-3}$	$\mu/{\rm cm}^2~{\rm V}^{-1}~{\rm s}^{-1}$	$\rho/\times 10^{-3}~\Omega~{\rm cm}$	$R_{\rm Sh}/\Omega$ $\Box^{-1}$	$T_{\lambda 550}/\%$	$T_{\lambda 400-700}/\%$
Undoped SnO <sub>2</sub>	0.40	N/A	N/A	N/A	N/A	80.9	80.8
0.1 mol%	0.40	0.80	22.5	3.48	87.1	81.6	82.2
0.25 mol%	0.40	2.23	27.6	1.00	25.0	84.5	83.8
0.5 mol%	0.40	2.44	35.2	0.73	18.2	76.7	79.3
1.0 mol%	0.40	1.70	34.1	1.08	27.0	82.8	82.4
1.5 mol%	0.40	2.73	17.8	1.31	32.7	74.0	73.4
5.0 mol%	0.40	2.76	23.6	0.96	24.0	76.0	74.4
7.5 mol%	0.40	N/A	N/A	N/A	N/A	76.1	72.6
Commercial stand	lards						
TECTM8	0.65	5.3	28	0.52	8.0	83	82
TEC™15	0.35	5.6	21	0.53	15.1	85	83
Asahi U™	0.90	2.2	32	0.88	9.8		

 $<sup>^</sup>a$  d: film thickness (±0.02 μm); n: charge carrier concentration;  $\mu$ : charge carrier mobility;  $\rho$ : bulk resistivity;  $R_{\rm sh}$ : sheet resistance;  $T_{\lambda550}$ ; transmittance at 550 nm;  $T_{\lambda400-700}$ : average transmittance over visible light range, 400–700 nm.

resistive for the Hall effect to measure the electrical properties. Increasing the amount of phosphorus doping (0.26–1.42 at% P in the films from 0.5–5 mol% triethyl phosphate precursor), however, had a dramatic impact on the resistivity values, as shown in Fig. 5. There was a clear trend observed in the data, where by increasing the phosphorus level from 0.1 to 0.5 mol% in solution led to films with improved electrical properties. The reduction in resistivity was accompanied by an increase in carrier density and mobility. At higher phosphorus doping, the electrical properties deteriorated, such that a slight increase in resistivity and reductions in charge carrier densities and mobilities were observed (films formed from 1.0 and 1.5 mol%)

triethyl phosphorus). Interestingly, the values recovered again around 5 mol% phosphorus in solution, before again becoming highly resistive above 7 mol%. The lowest resistivity values were for the films that were formed using 0.5 mol% triethyl phosphorus resulting in 0.26 at% P in the films. These films had resistivity values of  $7.27 \times 10^{-4} \, \Omega$  cm, sheet resistance of 18.2  $\Omega$   $\Box^{-1}$  and charge carrier mobility of 35.2  $\mu$  cm $^{-2}$  V $^1$  s $^1$ , these values are comparable to industry standards for F-doped SnO $_2$  thin films, as shown in Table 2.

Interestingly, the most conductive film (from 0.5 mol% triethyl phosphate) displayed preferential orientation in the (200) plane, which is commonly seen for highly conductive SnO<sub>2</sub>

Edge Article Chemical Science

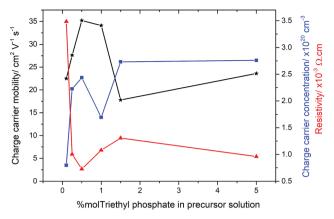


Fig. 5 Electrical properties for the P-doped  $SnO_2$  films as obtained by Hall effect measurements.

films.<sup>101,102</sup> However, the other films formed from 0.25, 1.0, 1.5 and 5 mol% P precursor, display preferred orientation in the (211) plane but were still highly conductive. This suggests that the origin of the increased electrical conductivity is not the product of a particular crystallographic orientation, but a mix of morphological and electronic contributions.

The most surprising value about the doping of these films is the low level of phosphorus required to achieve improvements in electrical properties. Even using only 0.1 mol% P precursor resulted in a significant increase in the electrical conductivity of the deposited films. Conversely increasing phosphorus concentrations above 1.5 mol%, the electrical properties deteriorated. This was accompanied by the films becoming highly coloured, with a yellow hue obvious in the deposited films. This suggests that the phosphorus forms colour centres when in higher concentrations, with these colour centres also acting as places where either recombination or deflection of the electrons can occur. <sup>103</sup> Although F-doping of SnO<sub>2</sub> also requires low levels of incorporation, between 0.5–1 at%, phosphorus doping by AACVD requires even smaller levels of incorporation into the lattice.

Using the Hall effect data it was also possible to establish the dominant scattering mechanism for the films. This was achieved by plotting the mobility values against the charge carrier concentrations. For all the samples synthesised for this study, the mobilities were relatively low (17–35 cm² V $^{-1}$  s $^{-1}$ ), whilst the charge carrier concentrations were relatively high (0.8–2.7  $\times$   $10^{20}$  cm $^{-3}$ ), this suggests that the dominant scattering mechanism for all samples is due to grain boundary scattering. This type of scattering mechanism is typical of polycrystalline SnO $_2$  thin films.  $^{104}$ 

These results show that phosphorus is an effective dopant for the synthesis of highly conductive n-type TCO thin films. Phosphorus doping also has a large impact on the preferred orientation and morphology of the films deposited, with low levels of phosphorus leading to round and rod-like particles with the development of pyramidal structures being observed at higher levels of doping, *ca.* 0.5 mol% triethyl phosphate in the precursor solution. Rod-like structures of SnO<sub>2</sub> have been used

for gas sensing applications, 105,106 so being able to select for this kind of morphology by incorporation of a dopant is of potential interest

Furthermore, phosphorus doping of SnO<sub>2</sub> opens up a new direction for the development of TCO materials synthesised by aerosol assisted CVD. Although the electrical properties of these films were not as high as for the best quoted values for F-doped SnO<sub>2</sub>, they are still comparable to industry standards. The phosphorus dopant, triethyl phosphate has low toxicity, whereas many of the fluorine precursors are highly toxic. This makes the handling, storage and disposal of the phosphorus precursor easier, cheaper and safer than for common fluorine precursors, such as ammonium fluoride.

#### 3.3 Computational modelling and results

The experimental work described above indicates that phosphorus is an effective n-type dopant for  $\mathrm{SnO}_2$  and functional properties required for TCOs can be achieved. In order to explore how the phosphorus contributes to the improvement of the functional properties of the deposited films computational models of phosphorus as a dopant for  $\mathrm{SnO}_2$  have been carried out. Phosphorus could potentially act both as an acceptor and donor dopant substituting on both O and Sn sites, as well as incorporating interstitially. Hence, theoretical calculations have been carried out on each of these defect environments as well as for the dominant intrinsic donor ( $\mathrm{V}_\mathrm{O}$ ) and acceptor ( $\mathrm{V}_\mathrm{Sn}$ ) defects.

The transition level diagrams under Sn-rich/O-poor, 900 K, 1 atm and Sn-poor/O-rich conditions are shown in Fig. 6.

Oxygen vacancies,  $V_{\rm O}$ , and tin vacancies,  $V_{\rm Sn}$ , act as the two lowest energy intrinsic donor and acceptor defects respectively in SnO<sub>2</sub>.  $V_{\rm O}$  is a negative-U defect and a deep donor with the 2+/0 transition level occurring  $\sim$ 0.76 eV below the conduction band minimum (CBM) and as such, does not contribute significantly to the conductivity. This behaviour is in keeping with other theoretical <sup>69,107,108</sup> and experimental <sup>109,110</sup> results.  $V_{\rm O}$  is a negative-U defect in other TCOs, such as ZnO, <sup>69,111-113</sup> In<sub>2</sub>O<sub>3</sub> (ref. 69 and 114–116) and BaSnO<sub>3</sub> (ref. 67) and has been identified *via* positron annihilation spectroscopy. <sup>117</sup> The neutral charge state of  $V_{\rm Sn}$  occurs very high in energy under all growth regimes (under favourable Sn-poor/O-rich conditions, the formation energy is  $\sim$ 8.37 eV) acting as a deep acceptor with the 0/1– transition level occurring  $\sim$ 1.75 eV above the VBM.

 $P_{Sn}$ . Under all three growth regimes  $P_{Sn}$  is the dominant donor P defect and is a shallow donor. Under Sn-rich/O-poor conditions, the formation energy of  $P_{Sn}^0$  is  $\sim 3.21$  eV and rises to  $\sim 4.53$  eV under Sn-poor/O-rich conditions making  $P_{Sn}$  a relatively high formation energy donor. This indicates that incorporation of P under equilibrium conditions could be difficult. However, non-equilibrium approaches such as sputtering or MBE (molecular beam epitaxy) might be a relatively facile way to achieve higher levels of doping. Large lattice relaxations could rationalise this due to the significantly smaller phosphorus ionic radii to Sn ( $\sim 50\%$  reduction in radii).<sup>118</sup> Although P does not shift from the original Sn position (through all charge states) a reduction of  $\sim 14\%$  is seen for the

**Chemical Science** 

Fig. 6 The charge transition level diagrams for Sn-rich/O-poor (left), 900 K, 1 atm (middle) and Sn-poor/O-rich (right). The Fermi energy goes from the VBM (0 eV) to  $\sim$ 2.4 eV above the CBM (which is at 3.6 eV). The conduction band region is depicted by the graded orange area.

Fermi Energy

P–O bond lengths (compared to Sn–O) which is commensurate with calculations carried out by Varley  $et~al.^{119}$  Varley et~al. also noticed that  $P_{Sn}$  acts a shallow donor with the electron occupying a conduction-band-like state. Work by Lany and coworkers have shown using HSE06 (Heyd–Scuzeria–Ernzerhoff) combined with GW (green's function) that  $P_{Sn}$  is a negative-U defect and that the 1+/1– transition level occurs  $\sim$ 0.4 eV and  $\sim$ 0.9 eV above the CBM for HSE06 and HSE06+GW respectively. <sup>120</sup> In our calculations, however, both the 1+/0 and 0/1– transition levels are seen  $\sim$ 0.65 and  $\sim$ 0.87 eV above the CBM respectively. Our work also shows that in the 1– charge state,  $P_{Sn}$  delocalises some of the extra charge and is therefore not a true acceptor state, this is shown in Fig. 7a.  $V_{Sn}^{-4-}$  becomes the

Fermi Energy (eV)

dominant compensating defect  $\sim 1.37$  eV above the CBM under Sn-rich/O-poor conditions and under Sn-poor/O-rich conditions  $V_{\rm Sn}^{4-}$  crosses  $P_{\rm Sn}^{1+}$  at  $\sim 0.2$  eV below the CBM. At 900 K, 1 atm compensation occurs at  $\sim 0.3$  eV above the CBM, which is consistent with degenerate n-type conductivity.

 $P_O$ .  $P_O$  is an amphoteric defect, acting as both a deep donor and a deep acceptor defect with the 1+/0 transition level occurring  $\sim$ 1.45 eV below the CBM and the 0/1– charge state occurs  $\sim$ 3.27 eV above the VBM which is in agreement with previous HSE06 studies.  $^{119}$   $P_O$  typically occurs relatively high in energy ( $\sim$ 5 eV under Sn-rich/O-poor conditions), most likely due to the relatively larger size of P to O. When incorporated, P shifts from the O site by around 3% in the a and b directions and

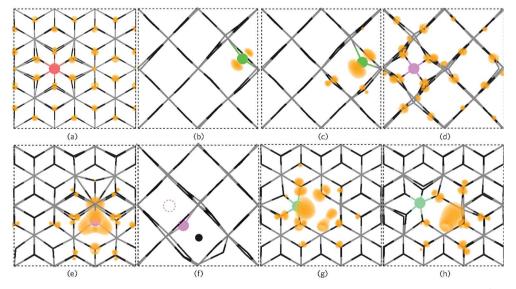


Fig. 7 The partial electron charge densities (orange) for (a)  $P_{Sn}$  viewed along {010} with a charge density of 0.002 eV  $A^{-1}$ , (b)  $P_O^{0}$  and (c)  $P_O^{1-}$  as viewed along the {001} direction with a charge density of 0.02 eV  $A^{-1}$ .  $P_I^{3+}$  is depicted in (d) along the {001} direction with a charge density of 0.008 eV  $A^{-1}$  and  $P_I^{3-}$  is shown in (e) along {010} with a charge density of 0.02 eV  $A^{-1}$  where a large triple polaron is seen. In (f),  $P_I^{3-}$  is viewed along the {001} axis presenting the displacement of a lattice O to an interstitial site by P (the original interstitial position is shown by the dashed circle). (g) and (h) displays the defect cluster  $[P_{Sn} + V_O]$  in both the neutral and 1+ charge states respectively as viewed along {010} and plotted from 0-0.01 eV  $A^{-1}$ . In each panel the  $SnO_2$  is depicted by the grey (Sn) and black (O) wire frame model with the P species colour coded to Fig. 6.

**Edge Article** 

a further 4% for the 1- charge state (which can be attributed to the increased electron localisation), this is shown in Fig. 7b and c for the neutral and 1- charge states respectively.

P<sub>i</sub>. Interstitial P (P<sub>i</sub>), whilst a shallow three electron donor, remains very high in energy under all growth conditions, under Sn-rich/O-poor conditions the formation energy of  $P_i^0$  is  $\sim 9.3$  eV.  $P_i$  is the dominant phosphorus defect at Fermi levels  $\sim$ 1.9 eV above the VBM until the formation of P<sub>Sn</sub> becomes more favourable (~2.1 eV above the VBM). Under more O-rich environments the  ${P_i}^{5+}/{P_{Sn}}^{1+}$  crossing point is pushed towards Fermi energies near the VBM. Being an amphoteric defect, Pi also acts as an acceptor, but any self-compensation occurs well above the conduction band minimum under all growth conditions. Large lattice distortions are seen for P<sub>i</sub> in the 5+, 4+, and 3+ allowing P to assume a PO<sub>4</sub> tetrahedral coordination, which has the effect of localising some of the electron charge on the adjacent Sn atoms. An illustration of this distortion for the 3+ charge state is shown in Fig. 7d, where the delocalised electron charge is seen. In the 3- charge state, P displaces an adjacent oxygen to the interstitial position (Fig. 7f), and a highly localised triple polaron forms on the P (Fig. 7e), however this charge state is highly unfavourable.

[P<sub>Sn</sub> + V<sub>O</sub>]. Extended X-ray absorption fine structure (EXAFS) experiments on Sb-doped SnO<sub>2</sub> have proposed the clustering of substitutional Sb with oxygen vacancies, which has also been corroborated through theoretical calculations. <sup>121,124</sup> A similar analysis can be carried out in P-doped SnO<sub>2</sub> by assessing the viability of such a cluster by calculating [Sb<sub>Sn</sub> + V<sub>O</sub>] in both a 'near' (neighbouring each other) and 'far' ( $\sim$ 8 Å apart) configuration. From our calculations, we find that the 'near' configuration is more favourable than the 'far' configuration by  $\sim$ 0.14 eV. A binding energy ( $E_{\rm BE}$ ) of 0.45 eV was calculated using:

$$E_{\rm BE} = E^{\rm [Sb_{Sn}+V_{\rm O}]} + E^{\rm host} - E^{\rm Sb_{Sn}} - E^{\rm V_{\rm O}}$$

Under Sn-rich/O-poor, 900 K, 1 atm and Sn-poor/O-rich growth conditions, the neutral charge state of [P<sub>Sn</sub> + V<sub>O</sub>] is 4.64 eV, 7.13 eV and 8.59 eV respectively. 121,122 It is likely, therefore, that this defect complex will form in negligible quantities or possibly form at high doping concentrations. [P<sub>Sn</sub> + V<sub>O</sub>] acts as a shallow one-electron donor in SnO<sub>2</sub> with the 1+/ 0 transition level occurring around 0.74 eV above the CBM. A further transition level (3+/1+) occurs in the band gap at 0.82 eV below the CBM. Fig. 7g and h show the partial charge electron density for [P<sub>Sn</sub> + V<sub>O</sub>] in both the neutral (Fig. 7g) and 1+ (Fig. 7h) charge states. In the neutral charge state, the electron density can be seen to localise on the P and in the oxygen vacancy. In the 1+ charge state, an electron has been removed from the P atom leaving two electrons in the oxygen vacancy. It is therefore reasonable to assume that phosphorus remains in the 5+ oxidation state and that the formation of this defect complex exists due to lattice strain.

Based on the above results, our calculations show that  $P:SnO_2$  is a shallow one-electron n-type donor allowing for good conductivities. Phosphorus does not suffer from self-

compensation issues like F:SnO2, 123 however, towards higher doping concentrations the incorporation of P may need a nonequilibrium deposition technique due to the increase in formation energy. The computational calculations agree with the experimental observations, such that phosphorus was incorporated as P<sup>5+</sup> (from XPS), and the conductivity of the films synthesised improved on doping SnO2 with phosphorus, with resistivity values of  $7.27 \times 10^{-4} \Omega$  cm and sheet resistance values of 18.2  $\Omega$   $\square$ <sup>-1</sup> achieved for the most conductive films, as expected for a one-electron n-type dopant. Moreover, only low dopant levels of P in the SnO<sub>2</sub> were achieved, which correlate with the theoretical results indicating that incorporation of P under equilibrium conditions could be difficult. Combining the experimental results with computational modelling allowed for the determination of the effectiveness of phosphorus as a dopant for SnO<sub>2</sub>.

### 4. Conclusions

P-doped SnO<sub>2</sub> thin films with excellent optical and electrical properties were synthesised by aerosol assisted chemical vapour deposition. The best performing films had a sheet resistance of 18.2  $\Omega$   $\square^{-1}$ , charge carrier mobility of 35.2  $\mu$  cm<sup>-2</sup> V<sup>1</sup> s<sup>1</sup> and resistivity of 7.27  $\times$  10<sup>-4</sup>  $\Omega$  cm<sup>-1</sup> which is comparable to industry standards. The phosphorus was shown to have significant impact on the preferential orientation, morphology and crystallinity of the films, with a range of different morphologies observed in the microstructure of the polycrystalline films. Combining the experimental results with computational modelling allowed the determination of the effectiveness of phosphorus as a dopant for SnO<sub>2</sub>. Phosphorus has been shown to be a shallow level n-type dopant with the electrons possessing excellent mobility. This synthetic route opens up the possibility of using a common element to dope SnO<sub>2</sub> films for transparent conducting oxide applications.

## **Author contributions**

S. B., M. J. P., D. B. P. and J. M. contributed experimental and characterisation techniques, B. A. D. W. contributed the computational modelling, D. O. S. and C. J. C. supervised the work, all authors contributed to writing the manuscript.

## Conflicts of interest

The authors declare no conflict of interest.

# Acknowledgements

The authors would like to thank the EPSRC for grants EP/L017709 and EP/N01572X/1 and UCL for an impact student-ship (D. B. P.). This work made use of the ARCHER UK National Supercomputing Service (http://www.archer.ac.uk) *via* our membership of the UK's HEC Materials Chemistry Consortium, which is also funded by the EPSRC (EP/L000202). The UCL Legion and Grace HPC Facilities (Legion@UCL and Grace@UCL) were also used in the completion of this work. Dr Sanjayan

Sathivasam is thanked for the EDX measurements. Pilkington Glass NSG limited is thanked for supplying glass substrates.

# References

**Chemical Science** 

- 1 Y. Ooyama, Y. Shimada, Y. Kagawa, I. Imae and Y. Harima, *Org. Biomol. Chem.*, 2007, 5, 2046–2054.
- 2 M. R. Leyden, L. K. Ono, S. R. Raga, Y. Kato, S. Wang and Y. Qi, J. Mater. Chem. A, 2014, 2, 18742–18745.
- 3 D. J. Lewis and P. O'Brien, *Chem. Commun.*, 2014, **50**, 6319–6321.
- 4 P. Marchand, I. A. Hassan, I. P. Parkin and C. J. Carmalt, *Dalton Trans.*, 2013, **42**, 9406–9422.
- 5 N. Noor and I. P. Parkin, J. Mater. Chem. C, 2013, 1, 984-996.
- 6 S. H. K. Park, M. Ryu, C. S. Hwang, S. Yang, C. Byun, J. I. Lee, J. Shin, S. M. Yoon, H. Y. Chu and K. I. Cho, *Electrochem. Solid-State Lett.*, 2008, 11, H10–H14.
- 7 B. Geffroy, P. Le Roy and C. Prat, *Polym. Int.*, 2006, 55, 572–582.
- 8 D. R. Cairns, D. C. Paine and G. P. Crawford, Appl. Phys. Lett., 2001, 78, 2643–2645.
- 9 S. W. Heo, Y. D. Ko, Y. S. Kim and D. K. Moon, J. Mater. Chem. C, 2013, 1, 7009–7019.
- 10 M. Bremer, P. Kirsch, M. Klasen-Memmer and K. Tarumi, Angew. Chem., Int. Ed., 2013, 52, 8880–8896.
- 11 S. Lee, S.-H. Kim, Y. Kim, A. I. Kingon, D. C. Paine and K. No, *Mater. Lett.*, 2012, 85, 88–90.
- 12 R. Pandey, C. H. Wie, X. Lin, J. W. Lim, K. K. Kim, D. K. Hwang and W. K. Choi, *Sol. Energy Mater. Sol. Cells*, 2015, **134**, 5–14.
- 13 K.-J. Ahn, J.-H. Park, B.-K. Shin, W. Lee, G. Y. Yeom and J.-M. Myoung, *Appl. Surf. Sci.*, 2013, 271, 216–222.
- 14 H. Faber, B. Butz, C. Dieker, E. Spiecker and M. Halik, *Adv. Funct. Mater.*, 2013, 23, 2828–2834.
- N. Rashidi, V. L. Kuznetsov, J. R. Dilworth, M. Pepper,
   P. J. Dobson and P. P. Edwards, J. Mater. Chem. C, 2013,
   1, 6960–6969.
- 16 A. Kafizas, N. Noor, P. Carmichael, D. O. Scanlon, C. J. Carmalt and I. P. Parkin, Adv. Funct. Mater., 2014, 24, 1758–1771.
- 17 C. Sotelo-Vazquez, N. Noor, A. Kafizas, R. Quesada-Cabrera, D. O. Scanlon, A. Taylor, J. R. Durrant and I. P. Parkin, Chem. Mater., 2015, 27, 3234–3242.
- 18 D. B. Potter, D. S. Bhachu, M. J. Powell, J. A. Darr, I. P. Parkin and C. J. Carmalt, *Phys. Status Solidi A*, 2016, 213, 1346–1352.
- 19 C. E. Knapp, G. Hyett, I. P. Parkin and C. J. Carmalt, *Chem. Mater.*, 2011, 23, 1719–1726.
- 20 S. Salam, M. Islam and A. Akram, *Thin Solid Films*, 2013, 529, 242–247.
- 21 M. M. Koebel, D. Y. Nadargi, G. Jimenez-Cadena and Y. E. Romanyuk, *ACS Appl. Mater. Interfaces*, 2012, 4, 2464–2473.
- 22 C. E. Knapp and C. J. Carmalt, *Chem. Soc. Rev.*, 2016, 45, 1036–1064
- 23 M. J. Powell and C. J. Carmalt, *Chem.-Eur. J.*, 2017, 23, 15543–15552.

- 24 M. J. Powell, D. B. Potter, R. L. Wilson, J. A. Darr, I. P. Parkin and C. J. Carmalt, *Mater. Des.*, 2017, **129**, 116–124.
- 25 D. Angmo, S. A. Gevorgyan, T. T. Larsen-Olsen, R. R. Søndergaard, M. Hösel, M. Jørgensen, R. Gupta, G. U. Kulkarni and F. C. Krebs, *Org. Electron.*, 2013, 14, 984–994.
- 26 L. Barraud, Z. Holman, N. Badel, P. Reiss, A. Descoeudres, C. Battaglia, S. De Wolf and C. Ballif, Sol. Energy Mater. Sol. Cells, 2013, 115, 151–156.
- 27 H. Kim, C. Gilmore, A. Pique, J. Horwitz, H. Mattoussi, H. Murata, Z. Kafafi and D. Chrisey, *J. Appl. Phys.*, 1999, 86, 6451–6461.
- 28 K. H. Kim, K. C. Park and D. Y. Ma, *J. Appl. Phys.*, 1997, **81**, 7764–7772.
- 29 D. S. Bhachu, G. Sankar and I. P. Parkin, *Chem. Mater.*, 2012, 24, 4704–4710.
- 30 Y. Wu, S. Potts, P. Hermkens, H. Knoops, F. Roozeboom and W. Kessels, *Chem. Mater.*, 2013, **25**, 4619–4622.
- 31 D. S. Bhachu, M. R. Waugh, K. Zeissler, W. R. Branford and I. P. Parkin, *Chem.–Eur. J.*, 2011, **17**, 11613–11621.
- 32 T. Fukano and T. Motohiro, *Sol. Energy Mater. Sol. Cells*, 2004, **82**, 567–575.
- 33 R. Bel Hadj Tahar, T. Ban, Y. Ohya and Y. Takahashi, J. Appl. Phys., 1998, 83, 2631–2645.
- 34 T. Minami, H. Nanto and S. Takata, *Jpn. J. Appl. Phys.*, 1984, 23, L280.
- 35 K. Ellmer, Nat. Photonics, 2012, 6, 809-817.
- 36 T. Minami, Thin Solid Films, 2008, 516, 5822-5828.
- 37 C. Candelise, M. Winskel and R. Gross, *Prog. Photovoltaics Res. Appl.*, 2012, **20**, 816–831.
- 38 C. Kılıç and A. Zunger, Phys. Rev. Lett., 2002, 88, 095501.
- 39 M. Adnane, H. Cachet, G. Folcher and S. Hamzaoui, *Thin Solid Films*, 2005, **492**, 240–247.
- 40 B. Benrabah, A. Bouaza, A. Kadari and M. Maaref, Superlattices Microstruct., 2011, 50, 591-600.
- 41 Y. Sun, W. D. Chemelewski, S. P. Berglund, C. Li, H. He, G. Shi and C. B. Mullins, *ACS Appl. Mater. Interfaces*, 2014, **6**, 5494–5499.
- 42 K. Peters, P. Zeller, G. Stefanic, V. Skoromets, H. Němec, P. Kužel and D. Fattakhova-Rohlfing, *Chem. Mater.*, 2015, 27, 1090–1099.
- 43 M. A. Gillispie, M. F. van Hest, M. S. Dabney, J. D. Perkins and D. S. Ginley, *J. Mater. Res.*, 2007, 22, 2832–2837.
- 44 S. woo Lee, Y.-W. Kim and H. Chena, *Appl. Phys. Lett.*, 2001, **78**, 350–351.
- 45 A. Simões, A. Ries, E. Souza, L. Perazolli, M. Cilense, E. Longo and J. A. Varela, *Ceram. Int.*, 2005, 31, 399–404.
- 46 Y. Wang, T. Brezesinski, M. Antonietti and B. Smarsly, *ACS Nano*, 2009, 3, 1373–1378.
- 47 M. Stefik, M. Cornuz, N. Mathews, T. Hisatomi, S. Mhaisalkar and M. Grätzel, *Nano Lett.*, 2012, **12**, 5431–5435.
- 48 V. Gokulakrishnan, S. Parthiban, K. Jeganathan and K. Ramamurthi, *J. Mater. Sci.*, 2011, 46, 5553–5558.
- 49 Y. S. Hsu and S. K. Ghandhi, *J. Electrochem. Soc.*, 1980, **127**, 1592–1595.

**Edge Article** 

50 K. H. Yoon and D. J. Nam, *J. Mater. Sci.*, 1995, **30**, 3415-3420.

- 51 L. Kőrösi, S. Papp, V. Meynen, P. Cool, E. F. Vansant and I. Dékány, *Colloids Surf.*, A, 2005, 268, 147–154.
- 52 J. Upadhyay, S. Vishwakarma and H. Prasad, *Thin Solid Films*, 1989, **169**, 195–204.
- 53 S. Vishwakarma and H. Prasad, J. Phys. D: Appl. Phys., 1993, 26, 959.
- 54 A. Kafizas, C. Crick and I. P. Parkin, *J. Photochem. Photobiol.*, *A*, 2010, **216**, 156–166.
- 55 G. Kresse and J. Furthmüller, Phys. Rev. B, 1996, 54, 11169.
- 56 G. Kresse and J. Furthmüller, *Comput. Mater. Sci.*, 1996, 6, 15–50.
- 57 G. Kresse and J. Hafner, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 1993, 47, 558.
- 58 G. Kresse and J. Hafner, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 1994, **49**, 14251.
- 59 P. E. Blöchl, Phys. Rev. B: Condens. Matter Mater. Phys., 1994, 50, 17953.
- 60 C. Adamo and V. Barone, *J. Chem. Phys.*, 1999, **110**, 6158–6170.
- 61 J. Paier, R. Hirschl, M. Marsman and G. Kresse, J. Chem. Phys., 2005, 122, 234102.
- 62 D. O. Scanlon and G. W. Watson, *J. Mater. Chem.*, 2012, 22, 25236–25245.
- 63 A. M. Ganose and D. O. Scanlon, *J. Mater. Chem. C*, 2016, 4, 1467–1475.
- 64 S. V. Farahani, T. D. Veal, J. J. Mudd, D. O. Scanlon, G. Watson, O. Bierwagen, M. White, J. S. Speck and C. F. McConville, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 2014, **90**, 155413.
- 65 Z. Lebens-Higgins, D. Scanlon, H. Paik, S. Sallis, Y. Nie, M. Uchida, N. Quackenbush, M. Wahila, G. Sterbinsky and D. A. Arena, *Phys. Rev. Lett.*, 2016, 116, 027602.
- 66 S. Sallis, D. Scanlon, S. Chae, N. Quackenbush, D. Fischer, J. Woicik, J.-H. Guo, S. Cheong and L. Piper, *Appl. Phys. Lett.*, 2013, 103, 042105.
- 67 D. O. Scanlon, Phys. Rev. B: Condens. Matter Mater. Phys., 2013, 87, 161201.
- 68 J. Suffner, P. Ágoston, J. Kling and H. Hahn, *J. Nanoparticle Res.*, 2010, **12**, 2579–2588.
- 69 P. Ágoston, K. Albe, R. M. Nieminen and M. J. Puska, *Phys. Rev. Lett.*, 2009, **103**, 245501.
- 70 J. P. Allen, D. O. Scanlon, L. F. Piper and G. W. Watson, J. Mater. Chem. C, 2013, 1, 8194–8208.
- 71 N. Quackenbush, J. Allen, D. Scanlon, S. Sallis, J. Hewlett, A. Nandur, B. Chen, K. Smith, C. Weiland and D. Fischer, *Chem. Mater.*, 2013, 25, 3114–3123.
- 72 R. M. Nieminen, Model. Simulat. Mater. Sci. Eng., 2009, 17, 084001.
- 73 N. Hine, K. Frensch, W. Foulkes and M. Finnis, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 2009, **79**, 024112.
- 74 S. T. Murphy and N. D. Hine, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 2013, **87**, 094111.
- 75 S. Lany and A. Zunger, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 2008, **78**, 235104.

- 76 C. Freysoldt, J. Neugebauer and C. G. Van de Walle, *Phys. Rev. Lett.*, 2009, **102**, 016402.
- 77 D. R. Lide, *CRC Handbook of Chemistry and Physics*, CRC Press, 86th edn, 2005.
- 78 M. W. Chase, NIST-JANAF Thermochemical Tables 2 Volume-Set (Journal of Physical and Chemical Reference Data Monographs), American Institute of Physics, 1998.
- 79 K. Reuter and M. Scheffler, Phys. Rev. B: Condens. Matter Mater. Phys., 2001, 65, 035406.
- 80 F. H. Taylor, J. Buckeridge and C. R. A. Catlow, *Chem. Mater.*, 2016, 28, 8210–8220.
- 81 B. J. Morgan and G. W. Watson, *J. Phys. Chem. C*, 2010, **114**, 2321–2328.
- 82 D. R. Stull and H. Prophet, JANAF thermochemical tables, DTIC Document, 1971.
- 83 W.-K. Choi, J.-S. Cho, S.-K. Song, H.-J. Jung and S.-K. Koh, *Jpn. J. Appl. Phys.*, 1996, 35, 5820.
- 84 F. Vicent, E. Morallo, C. Quijada, J. Va, A. Aldaz and F. Cases, *J. Appl. Electrochem.*, 1998, 28, 607–612.
- 85 M. Kwoka, L. Ottaviano, M. Passacantando, S. Santucci, G. Czempik and J. Szuber, *Thin Solid Films*, 2005, **490**, 36–42.
- 86 P. Boulanger, J. Pireaux, J. Verbist and J. Delhalle, *Polymer*, 1994, 35, 5185–5193.
- 87 T. Lindblad, B. Rebenstorf, Z.-G. Yan and S. L. T. Andersson, *Appl. Catal.*, *A*, 1994, **112**, 187–208.
- 88 A. Osaka, Y. Miura and T. Tsugaru, *J. Non-Cryst. Solids*, 1990, 125, 87–92.
- 89 D. S. Bhachu, R. G. Egdell, G. Sankar, C. J. Carmalt and I. P. Parkin, J. Phys. Chem. C, 2017, 5, 9694–9701.
- D. Belanger, J. Dodelet, B. Lombos and J. Dickson, J. Electrochem. Soc., 1985, 132, 1398–1405.
- 91 S.-Y. Lee and B.-O. Park, *Thin Solid Films*, 2006, **510**, 154–158.
- 92 A. Moholkar, S. Pawar, K. Rajpure, C. Bhosale and J. Kim, *Appl. Surf. Sci.*, 2009, 255, 9358–9364.
- 93 N. Noor and I. P. Parkin, Thin Solid Films, 2013, 532, 26-30.
- 94 D. F. Zhang, L. D. Sun, J. L. Yin and C. H. Yan, *Adv. Mater.*, 2003, 15, 1022–1025.
- 95 Q. Yu, L. A. Jauregui, W. Wu, R. Colby, J. Tian, Z. Su, H. Cao, Z. Liu, D. Pandey and D. Wei, *Nat. Mater.*, 2011, **10**, 443–449.
- 96 K. Kutsukake, N. Usami, Y. Ohno, Y. Tokumoto and I. Yonenaga, *Appl. Phys. Express*, 2013, **6**, 025505.
- 97 B. Alexandreanu, B. Capell and G. S. Was, *Mater. Sci. Eng.*, 2001, **300**, 94–104.
- 98 E. Elangovan and K. Ramamurthi, *Thin Solid Films*, 2005, **476**, 231–236.
- 99 C. Fitzgerald, M. Venkatesan, L. S. Dorneles, R. Gunning, P. Stamenov, J. M. D. Coey, P. Stampe, R. Kennedy, E. C. Moreira and U. S. Sias, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 2006, 74, 115307.
- 100 G. Liu, L. Wang, H. G. Yang, H.-M. Cheng and G. Q. M. Lu, J. Mater. Chem., 2010, 20, 831–843.
- 101 S. Nakao, N. Yamada, T. Hitosugi, Y. Hirose, T. Shimada and T. Hasegawa, *Appl. Phys. Express*, 2010, 3, 031102.

102 E. Elangovan and K. Ramamurthi, Appl. Surf. Sci., 2005,

- 103 D. Lang and L. Kimerling, Phys. Rev. Lett., 1974, 33, 489.
- 104 M. Prins, K.-O. Grosse-Holz, J. Cillessen and L. Feiner, *J. Appl. Phys.*, 1998, **83**, 888–893.
- 105 Y. J. Chen, X. Y. Xue, Y. G. Wang and T. H. Wang, *Appl. Phys. Lett.*, 2005, **87**, 233503–233505.
- 106 G. Xi and J. Ye, Inorg. Chem., 2010, 49, 2302-2309.

**Chemical Science** 

249, 183-196,

- 107 P. Ágoston, C. Körber, A. Klein, M. J. Puska, R. M. Nieminen and K. Albe, *J. Appl. Phys.*, 2010, **108**, 053511.
- 108 A. K. Singh, A. Janotti, M. Scheffler and C. G. Van de Walle, Phys. Rev. Lett., 2008, 101, 055502.
- 109 S. Samson and C. Fonstad, J. Appl. Phys., 1973, 44, 4618-4621.
- 110 P. King, R. Lichti, Y. Celebi, J. Gil, R. Vilão, H. Alberto, J. P. Duarte, D. Payne, R. Egdell and I. McKenzie, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 2009, **80**, 081201.
- 111 F. Oba, M. Choi, A. Togo and I. Tanaka, *Sci. Technol. Adv. Mater.*, 2011, **12**, 034302.
- 112 F. Oba, S. R. Nishitani, S. Isotani, H. Adachi and I. Tanaka, *J. Appl. Phys.*, 2001, **90**, 824–828.
- 113 A. Janotti and C. G. Van de Walle, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 2007, **76**, 165202.
- 114 A. Walsh, C. R. A. Catlow, A. A. Sokol and S. M. Woodley, Chem. Mater., 2009, 21, 4962–4969.

- 115 S. Lany and A. Zunger, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 2009, **80**, 085202.
- 116 A. Goyal, P. Gorai, H. Peng, S. Lany and V. Stevanović, *Comput. Mater. Sci.*, 2017, **130**, 1–9.
- 117 I. Makkonen, E. Korhonen, V. Prozheeva and F. Tuomisto, J. Phys.: Condens. Matter, 2016, 28, 224002.
- 118 R. T. Shannon, Acta Crystallogr., Sect. A: Cryst. Phys., Diffr., Theor. Gen. Crystallogr., 1976, 32, 751–767.
- 119 J. Varley, A. Janotti and C. Van de Walle, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 2010, **81**, 245216.
- 120 H. Peng, J. D. Perkins and S. Lany, *Chem. Mater.*, 2014, **26**, 4876–4881.
- 121 J. Rockenberger, U. Zum Felde, M. Tischer, L. Tröger, M. Haase and H. Weller, J. Chem. Phys., 2000, 112, 4296– 4304
- 122 V. Geraldo, V. Briois, L. V. D. A. Scalvi and C. Santilli, *J. Eur. Ceram. Soc.*, 2007, 27, 4265–4268.
- 123 J. E. Swallow, B. A. Williamson, T. J. Whittles, M. Birkett, T. J. Featherstone, N. Peng, A. Abbott, M. Farnworth, K. J. Cheetham and P. Warren, *Adv. Funct. Mater.*, 2017, 28, 1701900.
- 124 S. D. Ponja, B. O. Williamson, S. Sathasivam, D. O. Scanlon, I. P. Parkin and C. J. Carmalt, *J. Mater. Chem. C*, 2018, 6, 7257–7266.